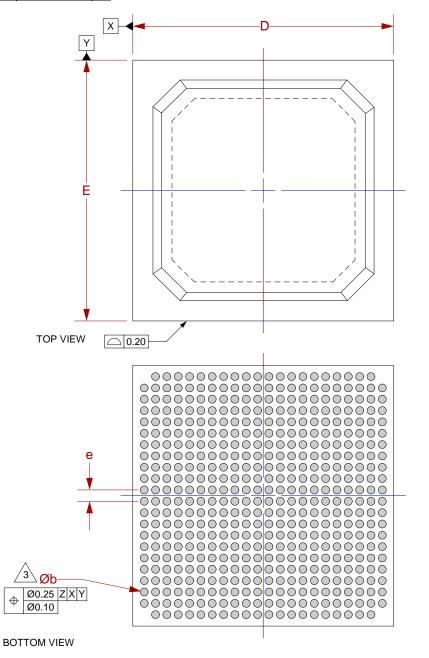
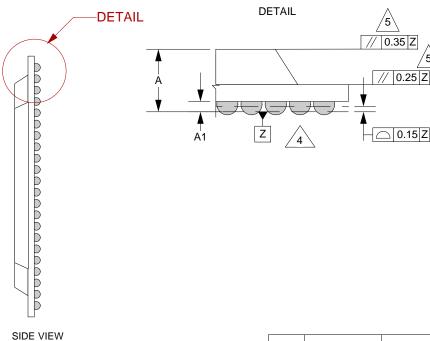


CBT-BGA-6006 Drawing	Status: Released	Scale: 3:1		Rev: A
© 2010 IRONWOOD ELECTRONICS, INC. Tele: (800) 404-0204	Drawing: S.Natarajan		Date: 12/18/2012	
www.ironwoodelectronics.com	File: CBT-BGA-6006 Dwg		Modified:	

Recommended PCB Layout Tolerances: ±0.025mm [±0.001"] unless stated otherwise.





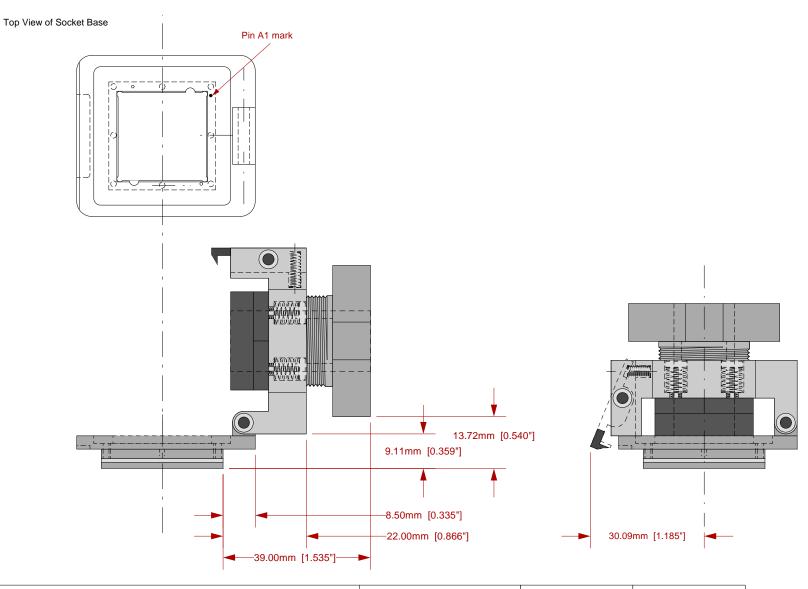
- 1. Dimensions are in millimeters.
- 2. Interpret dimensions and tolerances per ASME Y14.5M-1994.
- Dimension b is measured at the maximum solder ball diameter, parallel to datum plane Z.
- Datum Z (seating plane) is defined by the spherical crowns of the solder balls.
 - Parallelism measurement shall exclude any effect of mark on top surface of package.

DIM	MIN	MAX		
Α	1.85	2.11		
A1	0.3	0.5		
b		0.60		
D	23.00 BSC			
Е	23.00 BSC			
е	1.0 BSC			

0.25 Z

Array 22x22 480 pos.

	CBT-BGA-6006 Drawing	Status: Released	Scale	: -	Rev: A
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		CBT-BGA-6006 Drawing	Status: Released	Scale	: 3:1	Rev: A
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		www.ironwoodelectronics.com	File: CBT-BGA-6006 Dwg		Modified:	

All dimensions are in mm.
All tolerences are +/- 0.125mm.
(Unless stated otherwise)

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